

ES PATENT AND TRADEMARK OFFICE

Applicant:

Orcutt, et al.

Docket No.:

TI-32675

Serial No.:

10/085,507

Confirm. No.:

TBD

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02/26/2002

Examiner:

TBD

Title:

Optical Wireless Network Printed Circuit Board Micromirror Assembly

Having In-Package Mirror Position Feedback

TRANSMITTAL OF FORMAL DRAWINGS

Assistant Commissioner of Patents Washington, DC 20231

Attention: Official Drafts Person

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assis Commissioner For Patents, Washington, DC 20231.

Dear Sir:

Submitted herewith are 3 sheets of formal drawings.

Charge any necessary fee to Deposit Account No. 20-0668, Texas astroments Incorporated. This authorization is enclosed in triplicate.

Respectfully submitted,

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